onsemi

MOSFET – Power, Dual P-Channel

-40 V, -20 A, 12.5 mΩ FDWS9520L-F085

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low QG and Capacitance to Minimize Driver Losses
- Wettable Flanks for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Parameter			Symbol	Value	Unit	
Drain-to-Source Voltage			VDSS	-40	V	
Gate-to-Source Voltage			Vgs	±16	V	
Continuous Drain		$T_{C} = 25^{\circ}C$		-60.8	А	
Current R _{θJC} (Notes 1, 3)	Steady	$T_{C} = 100^{\circ}C$	I _D	-43.0		
Power Dissipation	State	$T_{C} = 25^{\circ}C$		75	w	
$R_{\theta JC}$ (Note 1)		$T_{C} = 100^{\circ}C$	P _D	37.5		
Continuous Drain Current $R_{\theta JA}$ (Notes 1, 2, 3)		$T_{C} = 25^{\circ}C$		-12.2	А	
	Steady State	$T_{C} = 100^{\circ}C$	I _D	-8.6		
Power Dissipation		$T_{C} = 25^{\circ}C$		3.0		
$R_{\theta JA}$ (Notes 1 & 2)		$T_{C} = 100^{\circ}C$	P _D	1.5	W	
Pulsed Drain Current $T_{C} = 25^{\circ}C, t_{p} = 10 \mu s$		Ідм	-281	А		
Operating Junction and Storage Temperature			TJ, Tstg	–55 to +175	°C	
Source Current (Body Diode)			۱ _S	-20	А	
Single Pulse Drain-to-Source Avalanche Energy (IL(pk) = -19)			Eas	90	mJ	
Lead Temperature for Soldering Purposes (1/83 from case for 10 s)			ΤL	260	°C	

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

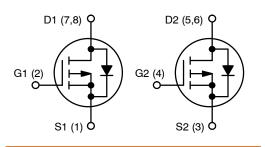
Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	R_{\thetaJC}	2	°C/W
Junction-to-Ambient - Steady State (Note 2)	R_{\thetaJA}	50	°C/W

 The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

 Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
–40 V	12.5 m Ω @ –10 V	–20 A
	19.5 mΩ @ –4.5 V	





ORDERING INFORMATION

See detailed ordering, marking and shipping information on page 3 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise noted)

Parameter	Symbol	Test Condition		Min	Тур	Мах	Unit
Off Characteristics							
Drain to Source Breakdown Voltage	V(BR)DSS	V _{GS} = 0 V, I _D = -250 μA		-40			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V(BR)DSS/ T _J				21		mV/°C
Zero Gate Voltage Drain Current	IDSS	V _{GS} = 0 V, V _{DS} = -40 V	T _J = 25°C			-1	μA
			T _J = 175°C			-1	mA
Zero Gate Voltage Drain Current	lgss	V _{DS} = 0 V, V _{GS} = ±16 V				±100	nA
On Characteristics (Note 4)		1					
Gate Threshold Voltage	Vgs(th)	V _{GS} = V _{DS,} I _D = -250 μA		-1	-1.8	-3	V
Threshold Temperature Coefficient	Vgs(th)/Tj				-5.5		mV/°C
brain-to-Source On Resistance	RDS(on)	V _{GS} = -10 V	I _D = -20 A		10.4	12.5	mΩ
		V _{GS} = -4.5 V	I _D = -10 A		14.6	19.5	-
Charges, Capacitances & Gate Resis	tance	VGS4.5 V			14.0	19.5	<u> </u>
Input Capacitance	Ciss	V _{GS} = 0 V, f = 1 MHz, V _{DS} = -20 V			2370		pF
Output Capacitance	Coss				940		pF
Reverse Transfer Capacitance	Crss			40		pF	
Gate Resistance	R _g	V _{GS} = 0.5 V, f = 1 MHz		17		Ω	
Total Gate Charge	QG(TOT)	$V_{GS} = -10 \text{ V}, \text{ V}_{DS} = -32 \text{ V}; \text{ I}_{D} = -20 \text{ A}$ $V_{GS} = -4.5 \text{ V}, \text{ V}_{DS} = -32 \text{ V}; \text{ I}_{D} = -20 \text{ A}$			33		nC
					13		1
Threshold Gate Charge	Qg(th)	V _{GS} = 0 to -1 V			2		
Gate to Source Gate Charge	Qgs	$V_{DD} = -20 V_{,} I_{D} = -20 A$			7		
Gate to Drain "Miller" Charge	Qgd				4		
Plateau Voltage	Vgp				-4		V
Switching Characteristics							
Turn-On Delay Time	td(ON)	$V_{DD} = -20 \text{ V}, \text{ I}_{D} = -20 \text{ A}, \text{ V}_{GS} = -10 \text{ V}, \\ \text{R}_{\text{GEN}} = 6 \Omega$			8		ns
Turn–On Rise Time	t _r				21		ns
Turn-Off Delay Time	td(OFF)				120		ns
Turn-Off Fall Time	t _f				34		ns
Drain-Source Diode Characteristics		1			L	I	L
Source to Drain Diode Voltage	Vsd	I _{SD} = -20 A, V _{GS}	= 0 V		-0.9	-1.25	V
-		I _{SD} = -10 A, V _{GS}			-0.83	-1.2	v
Reverse Recovery Time	TRR	$V_{GS} = 0 \text{ V}, \text{ dI}_{SD}/\text{dt} = 100 \text{ A/us}, \text{ I}_{S} = -20 \text{ A}$			46		ns
Charge Time	t _a	4			22		1
Discharge Time	t _b				24		1
Reverse Recovery Charge	QRR				37		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width \leq 300 μ s, duty cycle \leq 2% 5. Switching characteristics are independent of operating junction temperatures.

ORDERING INFORMATION

Device	Device Marking	Package	Shipping [†]
FDWS9520L-F085	FDWS9520L	PQFN8 5x6, 12.7P (Pb-Free, Halogen Free)	3,000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D

TYPICAL CHARACTERISTICS

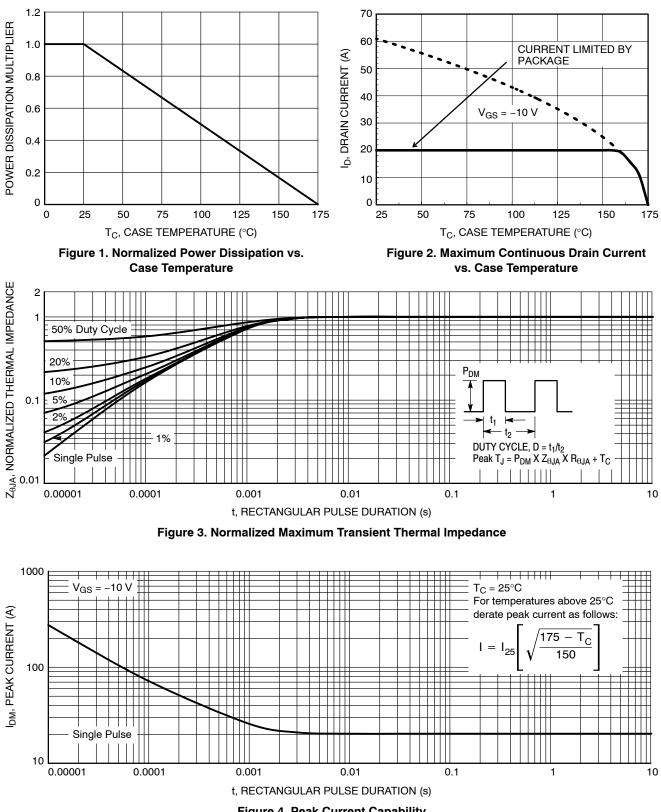
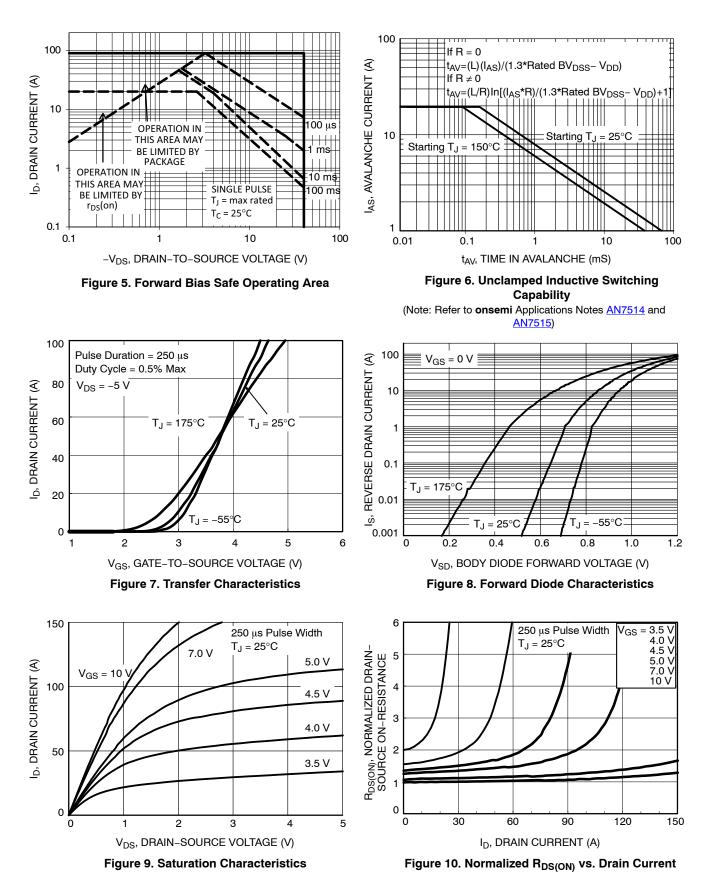
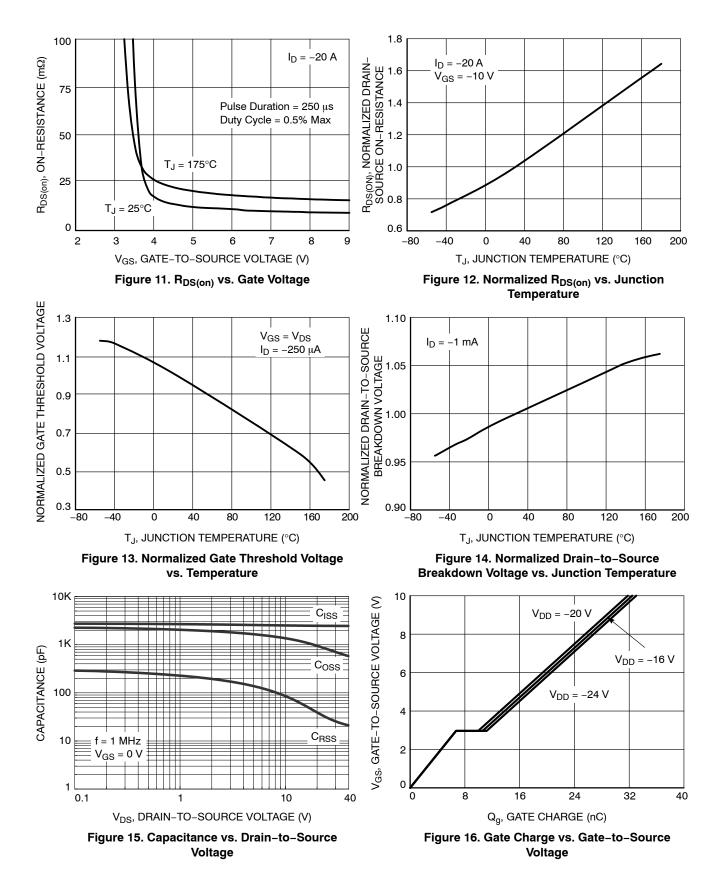


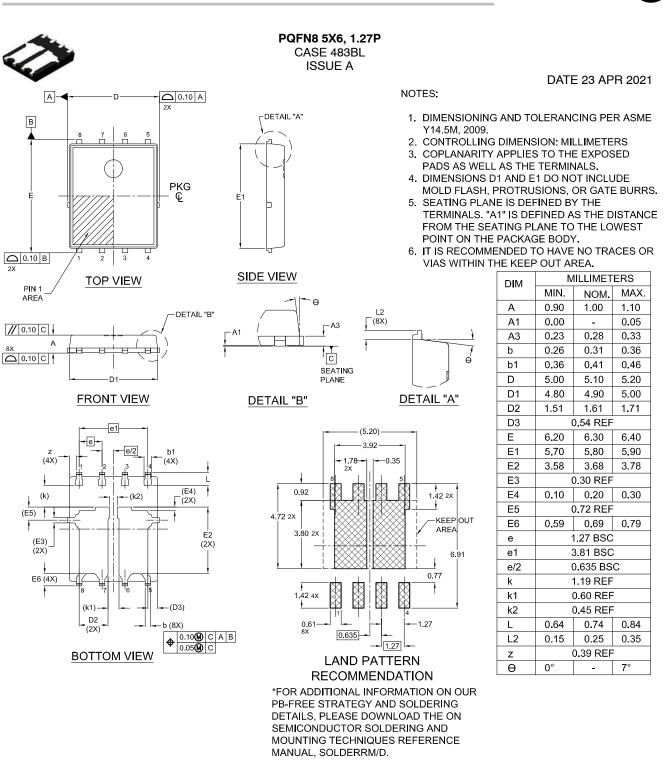
Figure 4. Peak Current Capability

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS





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